

# **LET9006**

## RF POWER TRANSISTORS

# Ldmos Enhanced Technology in Plastic Package

TARGET DATA

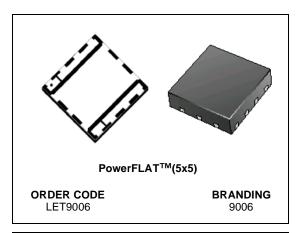
N-CHANNEL ENHANCEMENT-MODE LATERAL MOSFETs

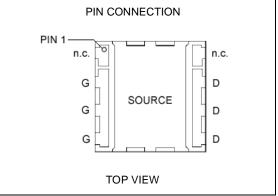
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- P<sub>OUT</sub> = 6 W with 17 dB gain @ 960 MHz / 26V
- NEW LEADLESS PLASTIC PACKAGE
- ESD PROTECTION
- SUPPLIED IN TAPE & REEL OF 3K UNITS

#### **DESCRIPTION**

The LET9006 is a common source N-Channel, enhancement-mode lateral Field-Effect RF power transistor. It is designed for high gain, broad band commercial and industrial applications. It operates at 26 V in common source mode at frequencies up to 1 GHz. LET9006 boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology mounted in the innovative leadless SMD plastic package, PowerFLAT<sup>TM</sup>.

It is ideal for digital cellular BTS applications requiring high linearity.





### ABSOLUTE MAXIMUM RATINGS (T<sub>CASE</sub> = 25 °C)

Symbol	Parameter	Value	Unit
V <sub>(BR)DSS</sub>	Drain-Source Voltage	65	V
V <sub>GS</sub>	Gate-Source Voltage	-0.5 to +15	V
ΙD	Drain Current	1	Α
P <sub>DISS</sub>	Power Dissipation (@ Tc = 70°C)	16	W
Tj	Max. Operating Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C

#### THERMAL DATA

-				
	$R_{th(j-c)}$	Junction -Case Thermal Resistance	5	°C/W

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## **ELECTRICAL SPECIFICATION (TCASE = 25 °C)**

### **STATIC**

Symbol		Test Condition	Min.	Тур.	Max.	Unit	
V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V	$I_D = 1 \text{ mA}$		65			
I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	$V_{DS} = 26 \text{ V}$				1	μΑ
I <sub>GSS</sub>	V <sub>GS</sub> = 5 V	V <sub>DS</sub> = 0 V				1	μΑ
V <sub>GS(Q)</sub>	V <sub>DS</sub> = 26 V	I <sub>D</sub> = TBD		2.0		5.0	V
V <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.5 A				0.9	V
9FS	V <sub>DS</sub> = 10 V	$I_D = 800 \text{ mA}$			TBD		mho
C <sub>ISS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF
Coss	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF
C <sub>RSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 26 V	f = 1 MHz		TBD		pF

### **DYNAMIC** (f = 960 MHz)

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
P <sub>OUT</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$	7	8		W
η <sub>D</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 6 \text{ W}$	55	65		%
Load mismatch	$V_{DD}$ = 26 V $I_{DQ}$ = TBD $P_{OUT}$ = 6 W ALL PHASE ANGLES			10:1	VSWR

(1) 1 dB Compression point

### **DYNAMIC** (*f* = 920 - 960 MHz)

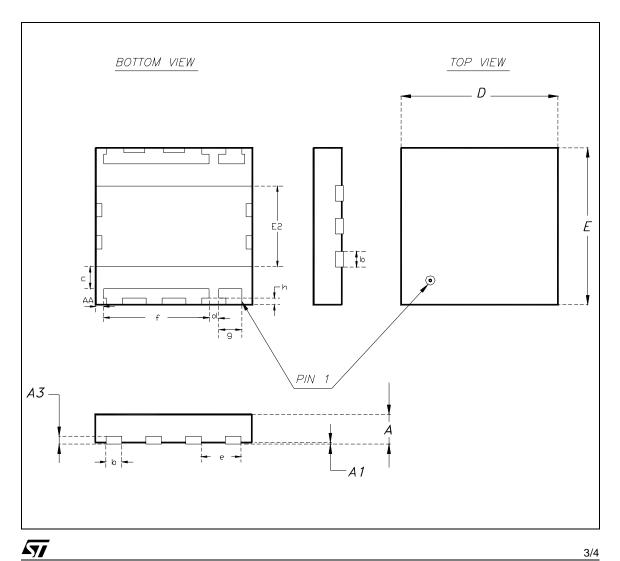
Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Pout <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$	6	7		W
G <sub>P</sub>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 6 \text{ W}$	17			dB
η <sub>D</sub> <sup>(1)</sup>	$V_{DD} = 26 \text{ V}$ $I_{DQ} = TBD$ $P_{OUT} = 6 \text{ W}$	55	60		%

(1) 1 dB Compression point

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## PowerFLAT<sup>™</sup> MECHANICAL DATA

DIM.		mm			Inch	
Dilvi.	MIN.	TYP.	MAX	MIN.	TYP.	MAX
Α		0.90	1.00		0.035	0.039
A1		0.02	0.05		0.001	0.002
А3		0.24			0.009	
AA	0.15	0.25	0.35	0.006	0.01	0.014
b	0.43	0.51	0.58	0.017	0.020	0.023
С	0.64	0.71	0.79	0.025	0.028	0.031
D		5.00			0.197	
d		0.30			0.011	
E		5.00			0.197	
E2	2.49	2.57	2.64	0.098	0.101	0.104
е		1.27			0.050	
f		3.37			0.132	
g		0.74			0.03	
h		0.21			0.008	



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